## BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS031031006-SF-10E

Description: 31.00 x 31.00 x 6.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin

Heat Sink Attachment: N/A
Equivalent Part Number: N/A

\*Image above is for illustration purpose only.

## **Features & Benefits**

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- · Fabricated from extruded aluminum, which minimizes thermal resistance from the base to the fins, reduces weight and keeps costs low
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	16.96 °C/W	11.1 °C/W	8.7 °C/W	7.4 °C/W	6.6 °C/W	6 °C/W	5.6 °C/W
	Ducted Flow	6.1	5.1	4.5	4.1	3.8	3.6	3.4

## **Product Detail**



